

#### Features

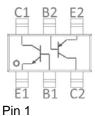
Complementary Pair. One 2SK2412K-Type NPN. One 2SA1037AK-Type PNP. Transistor elements independent,eliminating interference Mounting cost and area can be cut in half.

## Package Marking and Ordering Information

Product ID Pack		Marking	Qty(PCS)
UMZ1NTR	SOT-363(SC-70-6)	Z1	3000



SOT-363 (SC-70-6)

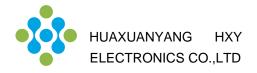


#### Maxmim Ratings (Ta=25 unless otherwise noted)

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	60	V
V <sub>CEO</sub>	Collector-Emitter Voltage	50	V
V <sub>EBO</sub>	EBO Emitter-Base Voltage		V
lc	Collector Current	150	mA
Pc	P <sub>C</sub> Collector Power Dissipation		mW
R <sub>ØJA</sub>	R <sub>OJA</sub> Thermal Resistance From Junction To Ambient		°C/W
T <sub>J</sub> ,T <sub>stg</sub>	Operation Junction And Storage Temperature Range	-55~+150	°C

## 2SAK2412 Electrcal Charcteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Туе	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =50μΑ,I <sub>E</sub> =0	60			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =1mA,I <sub>B</sub> =0	50			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> =50μΑ,I <sub>C</sub> =0	7			V
Collector cut-off current	I <sub>CBO</sub>	$V_{CB}$ =60V,I <sub>E</sub> =0			0.1	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =7V,I <sub>C</sub> =0			0.1	μA
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> =6V,I <sub>C</sub> =1mA	120		560	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =50mA,I <sub>B</sub> =5mA			0.4	V
Transition frequency	f⊤	V <sub>CE</sub> =12V,I <sub>C</sub> =2mA,f=100MHz		180		MHz
Collector output capacitance	C <sub>ob</sub>	V <sub>CB</sub> =12V,I <sub>E</sub> =0,f=1MHz		2.0	3.5	pF



## Maxmim Ratings (Ta=25 unless otherwise noted)

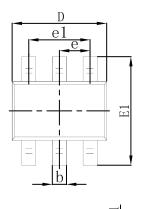
Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	-60	V
VCEO	Collector-Emitter Voltage	-60	V
V <sub>EBO</sub>	V <sub>EBO</sub> Emitter-Base Voltage		V
lc	I <sub>C</sub> Collector Current		mA
Pc	P <sub>c</sub> Collector Power Dissipation		mW
R <sub>ØJA</sub>	R <sub>OJA</sub> Thermal Resistance From Junction To Ambient		°C <b>/W</b>
TJ ,Tstg	J, T <sub>stg</sub> Operation Junction And Storage Temperature Range		°C

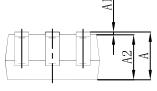
# 2SA1037AK Electrcal Charcteristics (Ta=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Туе	Max	Unit
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =-50μΑ,I <sub>E</sub> =0	-60			V
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =-1mA,I <sub>B</sub> =0	-50			V
Emitter-base breakdown voltage	V <sub>(BR)EBO</sub>	Ι <sub>Ε</sub> =-50μΑ,Ι <sub>C</sub> =0	-6			V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =-60V,I <sub>E</sub> =0			-0.1	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =-6V,I <sub>C</sub> =0			-0.1	μA
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> =-6V,I <sub>C</sub> =-1mA	120		560	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =-50mA,I <sub>B</sub> =-5mA			-0.5	V
Transition frequency	f⊤	V <sub>CE</sub> =-12V,I <sub>C</sub> =-2mA,f=100MHz		140		MHz
Collector output capacitance	C <sub>ob</sub>	V <sub>CB</sub> =-12V,I <sub>E</sub> =0,f=1MHz			5	pF



## SOT-363(SC-70-6) Package Outline Dimensions

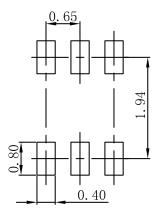




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L			ш
		0.20 <u>c</u>	

Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.150	0.350	0.006	0.014	
С	0.100	0.150	0.004	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.400	0.085	0.094	
е	e 0.650 TYP		0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021 REF		
L1 0.260		0.460	0.010	0.018	
θ	0°	8°	0°	8°	

### SOT-363 (SC-70-6) Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.



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